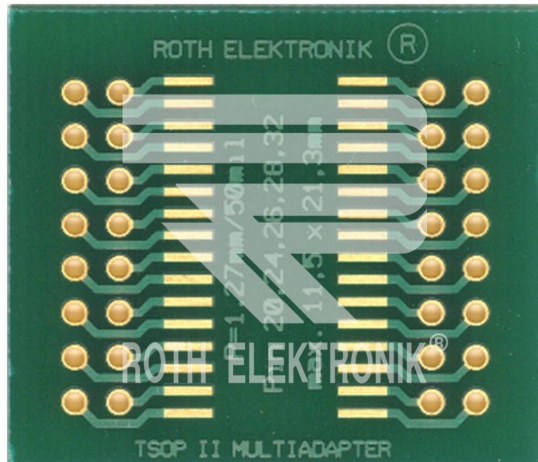


Adapter TSOP II



RE900-06

- FR4 EPOXY fibre-glass FR4 1.50 mm double-sided 35 µm CU (pth)
- solder and component side with chemical Ni/AU surface and solder stop mask
- pitch spacings:
1.27 mm (50 mil)
- Pins:
20, 24, 26, 28, 32
- hole dia Ø 1.00 mm
- Gerber data for manufacture of the soldering paste imprint will be provided free of charge on request
- size: 26.5 x 30.5 mm